

LML0040-VB Datasheet

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY

| V_{DS} (V) | $R_{DS(on)}$ (Ω) | I_D (A) ^a | Q_g (Typ.) |
|--------------|---------------------------|------------------------|--------------|
| 30 | 0.030 at $V_{GS} = 10$ V | 6.5 | 4.5 nC |
| | 0.033 at $V_{GS} = 4.5$ V | 6.0 | |

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- DC/DC Converter



ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ\text{C}$, unless otherwise noted

| Parameter | Symbol | Limit | Unit |
|--|--------------------------|---------------------|------------------|
| Drain-Source Voltage | V_{DS} | 30 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | |
| Continuous Drain Current ($T_J = 150^\circ\text{C}$) | $T_C = 25^\circ\text{C}$ | 6.5 ^a | A |
| | $T_C = 70^\circ\text{C}$ | 6.0 | |
| | $T_A = 25^\circ\text{C}$ | 5.3 | |
| | $T_A = 70^\circ\text{C}$ | 5.0 | |
| Pulsed Drain Current | I_{DM} | 25 | A |
| Continuous Source-Drain Diode Current | $T_C = 25^\circ\text{C}$ | 1.4 | |
| | $T_A = 25^\circ\text{C}$ | 0.9 ^{b, c} | |
| Maximum Power Dissipation | $T_C = 25^\circ\text{C}$ | 1.7 | W |
| | $T_C = 70^\circ\text{C}$ | 1.1 | |
| | $T_A = 25^\circ\text{C}$ | 1.1 ^{b, c} | |
| | $T_A = 70^\circ\text{C}$ | 0.7 ^{b, c} | |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | - 55 to 150 | $^\circ\text{C}$ |
| Soldering Recommendations (Peak Temperature) ^{d, e} | | 260 | |

THERMAL RESISTANCE RATINGS

| Parameter | Symbol | Typical | Maximum | Unit |
|---|------------|---------|---------|--------------------|
| Maximum Junction-to-Ambient ^{b, d} | R_{thJA} | 90 | 115 | $^\circ\text{C/W}$ |
| Maximum Junction-to-Foot (Drain) | R_{thJF} | 60 | 75 | |

Notes:

- Package limited
- Surface Mounted on 1" x 1" FR4 board.
- $t = 5$ s.
- Maximum under steady state conditions is 130°C/W .

| SPECIFICATIONS T _J = 25 °C, unless otherwise noted | | | | | | |
|---|--------------------------------------|--|------|-------|-------|-------|
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = 250 μA | 30 | | | V |
| V _{DS} Temperature Coefficient | ΔV _{DS} /T _J | I _D = 250 μA | | 31 | | mV/°C |
| V _{GS(th)} Temperature Coefficient | ΔV _{GS(th)} /T _J | | | - 5 | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 0.7 | 1.1 | 2.0 | V |
| Gate-Source Leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = ± 20 V | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 30 V, V _{GS} = 0 V | | | 1 | μA |
| | | V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C | | | 10 | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} ≥ 5 V, V _{GS} = 10 V | 10 | | | A |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 3.2 A | | 0.030 | | Ω |
| | | V _{GS} = 4.5 V, I _D = 2.8 A | | 0.033 | | |
| Forward Transconductance ^a | g _{fs} | V _{DS} = 15 V, I _D = 4.8 A | | 11 | | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz | | 335 | | pF |
| Output Capacitance | C _{oss} | | | 45 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 17 | | |
| Total Gate Charge | Q _g | V _{DS} = 15 V, V _{GS} = 10 V, I _D = 3.4 A | | 4.5 | 6.7 | nC |
| | | V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 3.4 A | | 2.1 | 3.2 | |
| Gate-Source Charge | Q _{gs} | | | 0.85 | | |
| Gate-Drain Charge | Q _{gd} | | | 0.65 | | |
| Gate Resistance | R _g | f = 1 MHz | 0.8 | 4.4 | 8.8 | Ω |
| Turn-On Delay Time | t _{d(on)} | V _{DD} = 15 V, R _L = 5.6 Ω I _D ≅ 2.7 A, V _{GEN} = 4.5 V, R _g = 1 Ω | | 12 | 20 | ns |
| Rise Time | t _r | | | 50 | 75 | |
| Turn-Off Delay Time | t _{d(off)} | | | 12 | 20 | |
| Fall Time | t _f | | | 22 | 35 | |
| Turn-On Delay Time | t _{d(on)} | V _{DD} = 15 V, R _L = 5.6 Ω I _D ≅ 2.7 A, V _{GEN} = 10 V, R _g = 1 Ω | | 5 | 10 | |
| Rise Time | t _r | | | 12 | 20 | |
| Turn-Off Delay Time | t _{d(off)} | | | 10 | 15 | |
| Fall Time | t _f | | | 5 | 10 | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | | | 1.4 | A |
| Pulse Diode Forward Current | I _{SM} | | | | 15 | |
| Body Diode Voltage | V _{SD} | I _S = 2.7 A, V _{GS} = 0 V | | 0.8 | 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | I _F = 2.7 A, dI/dt = 100 A/μs, T _J = 25 °C | | 10 | 20 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 5 | 10 | nC |
| Reverse Recovery Fall Time | t _a | | | 6 | | ns |
| Reverse Recovery Rise Time | t _b | | | 4 | | |

Notes:

a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Output Characteristics



Transfer Characteristics



On-Resistance vs. Drain Current and Gate Voltage



Capacitance

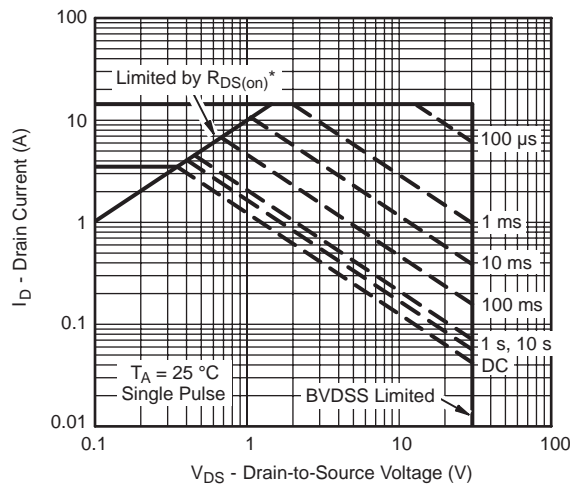


Gate Charge



On-Resistance vs. Junction Temperature

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified
Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

SOT-23 (TO-236): 3-LEAD



| Dim | MILLIMETERS | | INCHES | |
|---|-------------|------|------------|-------|
| | Min | Max | Min | Max |
| A | 0.89 | 1.12 | 0.035 | 0.044 |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 |
| b | 0.35 | 0.50 | 0.014 | 0.020 |
| c | 0.085 | 0.18 | 0.003 | 0.007 |
| D | 2.80 | 3.04 | 0.110 | 0.120 |
| E | 2.10 | 2.64 | 0.083 | 0.104 |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 |
| e | 0.95 BSC | | 0.0374 Ref | |
| e ₁ | 1.90 BSC | | 0.0748 Ref | |
| L | 0.40 | 0.60 | 0.016 | 0.024 |
| L ₁ | 0.64 Ref | | 0.025 Ref | |
| S | 0.50 Ref | | 0.020 Ref | |
| q | 3° | 8° | 3° | 8° |
| ECN: S-03946-Rev. K, 09-Jul-01 DWG: 5479 | | | | |

RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads
Dimensions in Inches/(mm)

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